



Docket No.: H0498.70155US00
(PATENT)


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hong Yang et al.
Serial No.: 09/940072
Confirmation No.: 3068
Filed: August 27, 2001
For: FABRICATION OF CERAMIC MICROSTRUCTURES
Examiner: Carlos Lopez
Art Unit: 1731

Certificate of Mailing Under 37 CFR 1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: 1-24-06


Signature

AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116

MS RCE

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Final Office Action dated July 24, 2005, please amend the above-identified U.S. patent application as follows:

The Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.